

# GlueX Electronics Status

Collaboration Meeting  
November 10, 2005

P. Smith

# Since May:

- June 1: Drift Chamber Conference Call: GlueX-doc-519
- July 1: Meeting at IU: GlueX-doc-524
- September 9: Conference Call: GlueX-doc-531
- October 4: Tracking Workshop at Ohio U: GlueX-doc-534
- October 5: Preamp Conference Call: GlueX-doc-535
- November 9: Meeting at JLab

**Summary of GlueX Detector Subsystems**  
 12 October 2005 P. Smith

Detector	Photon tagger	Pair spectrometer	Upstream Photon veto	Start counter	Central drift	Forward drifts	DIRC	Time-of-flight	Barrel calorimeter	Forward calorimeter
<b>Type</b>	Scintillator	Si microstrip	Scintillator	Scintillator	Straw tube	Planar chamber	Quartz	Scintillator	Sci fibers	Lead glass
<b>Channel count</b>	140 fixed 120 movable	2048	112	40	3240	2,856 anode 11,424 cathode	2000 TDC 32 FADC	168	2112	2500
<b>Signal source</b>	PMT fixed SiPMT movable	Silicon microstrip	PMT	PMT	Straw tube	anode wires cathode strips	Multi-anode PMT	PMT	SiPMT	PMT
<b>Physics signal</b>	100 pe	22000 e	100 pe	100 pe	338 e	94 e	25 pe	500 pe	250 pe/GeV	250 pe/GeV.
<b>Energy resolution</b>	0.1% (segmentation)	N/A	10%/√E	N/A	15%	15%	N/A.	N/A	2% + 5%/√E	3.6% + 7.3%/√E
<b>Time resolution</b>	100 ps	25 ns	1 ns	350 ps	2 ns	2 ns	200 ps	80 ps	150 + 50/√E ps	400 ps
<b>Gain in detector</b>	10 <sup>6</sup>	1	10 <sup>6</sup>	10 <sup>6</sup>	2 x 10 <sup>4</sup>	10 <sup>5</sup>	10 <sup>6</sup>	10 <sup>6</sup>	8 x 10 <sup>5</sup>	8 x 10 <sup>5</sup>
<b>Typical charge</b>	16 pC	3.5 fC	16 pC	16 pC	1 pC	1.5 pC anodes 0.3 pC cathodes	4 pC	80 pC	32 pC/GeV	32 pC/GeV
<b>Signal range</b>	5	10	100	10	3 pC max 100 fC min	Anodes: 0.3 pC → 3 pC Cathodes: 10 fC → 1 pC	10	10	160 pC max 1.6 pC min 0.16 pC lsb	160 pC max 1.6 pC min 0.16 pC lsb
<b>Preamp gain</b>	no	10 <sup>4</sup>	no	no	250	250	10	no	no	no
<b>Maximum single channel rate</b>	5 MHz	1 MHz	1 MHz	10 MHz	600 KHz	140 KHz	250 KHz	6 MHz	1.4 MHz	2 MHz
<b>Discrimination</b>	constant fraction	no	no	constant fraction	no	Maybe? (anode) no (cathode)	yes	constant fraction	yes	no
<b>FADC</b>	8 bits 250 Msps	12 bits 62.5 Msps	8 bits 250 Msps	8 bits 250 Msps	10 - 12 bits 125 Msps	Anodes?: Cathodes: 12 bits 62.5 Msps	8 bits 250 Msps	8 bits 250 Msps	8 bits 250 Msps 0.5 V fs	8 bits 250 Msps 0.5 V fs
<b>TDC</b>	62 ps	no	no	62 ps	no	Anodes?: 125 ps	125 ps	62 ps	62 ps	no
<b>Level 1 trigger</b>	yes (low rate runs)	no	no	track count	no	no	no	track count	energy sum	energy sum

Detector	Type	Channels	Modules	Crates	Racks
<b>Photon Tagger</b>	6U, 16 channel, 8 bit, 250 Msps FADC	260	17	1 DAQ	2
	6U, 32 channel, 62 ps TDC	260	9	1 DAQ	
	High voltage	150	13	1 HV	
	8 channel CFD	250	32	2 DISC	
<b>Pair Polarimeter</b>	6U, 64 channel, 10 bit, 62.5 Msps FADC	2048	32	2 DAQ	1
<b>Upstream Photon Veto</b>	6U, 16 channel, 8 bit, 250 Msps FADC	24	2	1 DAQ	1
	High voltage	24	2		
<b>Start Counter</b>	6U, 16 channel, 8 bit, 250 Msps FADC	40	3		
	6U, 32 channel, 62 ps TDC	40	2		
	High voltage	40	4		
	8 channel CFD	40	5	1 DISC	
<b>Central Drift</b>	6U, 16 channel, 125 Msps FADC	3240	203	13 DAQ	5
	High voltage	60	2		
	Gas				
<b>Forward Drift anodes</b>	6U, 16 channel, 125 Msps FADC	2900	182	12 DAQ	5
	High voltage	300	7	1 HV	
<b>Forward Drift cathodes</b>	6U, 64 channel, 10 bit, 62.5 Msps FADC	11,400	179	12 DAQ	4
	Gas				2
<b>DIRC</b>	8 channel CFD	2000	250	16 DISC	4
	6U, 16 channel, 8 bit, 250 Msps FADC	32	2		
	6U, 64 channel, 125 ps TDC	2000	32	2 DAQ	
	High voltage	32	3	1 HV	
<b>Time of Flight</b>	8 channel CFD	168	21	2 DISC	2
	6U, 32 channel, 62 ps TDC	168	6		
	6U, 16 channel, 8 bit, 250 Msps FADC	168	11	1 DAQ	
	High voltage	168	14	1 HV	
<b>Barrel Calorimeter</b>	6U, 16 channel, 8 bit, 250 Msps FADC with energy sum	2112	132	9 DAQ	11
	6U, 32 channel, 62 ps TDC	2112	66	5 DAQ	
	8 channel CFD	2112	264	17 DISC	
<b>Forward Calorimeter</b>	6U, 16 channel, 8 bit, 250 Msps FADC with energy sum	2500	157	10 DAQ	4
	Cockcroft Walton control, misc			1 DISC	1
<b>Level 1 Trigger</b>				3 DAQ	1
<b>Totals</b>				115	46

# Detector electronics R&D issues:

- Beamline: Pair Spectrometer, Polarimeter ? Details needed.
- CDC: # of primary electrons, gain in chamber  
Channel count for beam tests? Sampling rate?
- FDC: # of primary electrons, gain in chamber  
dE/dX: cathodes, anodes, TDC, ADC  
Channel count for beam tests? Sampling rates?
- DIRC vs Gas Cerenkov ?
- BCAL: channel count, photodetectors  
Discs, TDCs ?
- Trigger: energy sums, “track” count(s), other?  
Level I algorithm
- Electronics & DAQ: clocking, trigger, event building, etc.
- Tagger: JLab FI TDC with/without accelerator clock sync

# Money:

- Struck SIS3320 200 Msps VME FADC - 2? @ \$7k - anodes
- Struck SIS3300 100 Msps VME FADC - 3? @ \$5k - cathodes
- Preamps:
  - ▶ Design @ \$31k??
  - ▶ MOSIS prototype @ \$27k??? (40 chips)
  - ▶ Production @ \$120k???? (2400 chips)
- VME Test crates, CPUs - 5? @ \$12k?
- JLab FI TDCs @ \$3.7k, fADCs @ \$4k
- IUCF Tracking fADCs - 5 @ \$37k

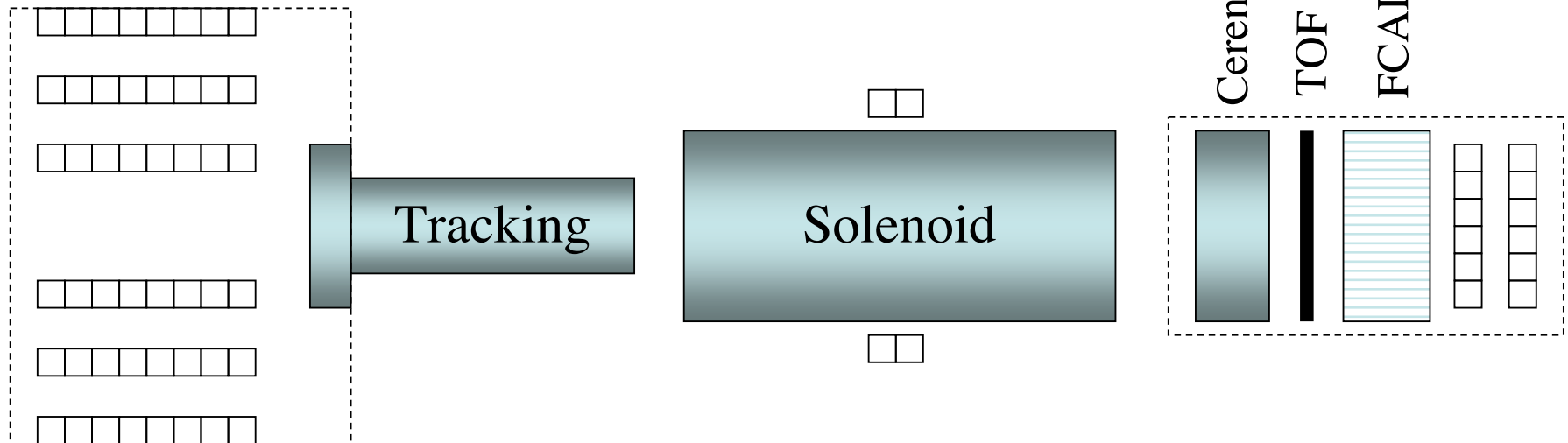
# “Civil”

- Cables:
  - ▶ From CDR chapter 6: “All detector electronics will be located near the detector itself. This will minimize cable lengths and eliminate the need for large cable runs from the detector to electronic racks far from the detector. The racks of electronics servicing the inner detectors will be located on a platform upstream of the magnet with ample space for access. A possible Access Platform is shown in Fig.6.90 with the **primary aim being that detectors can be operated both inside and outside the solenoid without making any disconnections**. This implies that either the cabling for start detector, cdc and fdc will have enough slack so that they can be moved in or out of the magnet without any disconnections, or that the electronics will themselves move along with the detector elements. **It is crucial that the detectors can be operated in the extracted position for testing and the installed position during normal operation without wiring changes.**”
  - ▶ From CDR chapter 7: “The readout electronics will be located as close to the detector as possible to minimize signal cable runs. Note that the Tagger electronics will be located in a separate building 80 meters upstream of the main detector. The Time of Flight and Forward Calorimeter electronics will be downstream of these detectors. Cabling from detectors inside the solenoid will exit at the upstream and downstream ends of the magnet and connect to nearby electronics. Fiber optic cables will transport the data from the crate readout processors to the level 3 trigger processor farm in the counting house.”
  - ▶ Clock, Reset, Trigger, Test Pulse distribution: optical fibers
  - ▶ Tagger to/from LI Trigger: optical fibers
  - ▶ DAQ: Fibers to/from Counting House
- Tracking preamp heat: 1000? watts inside magnet

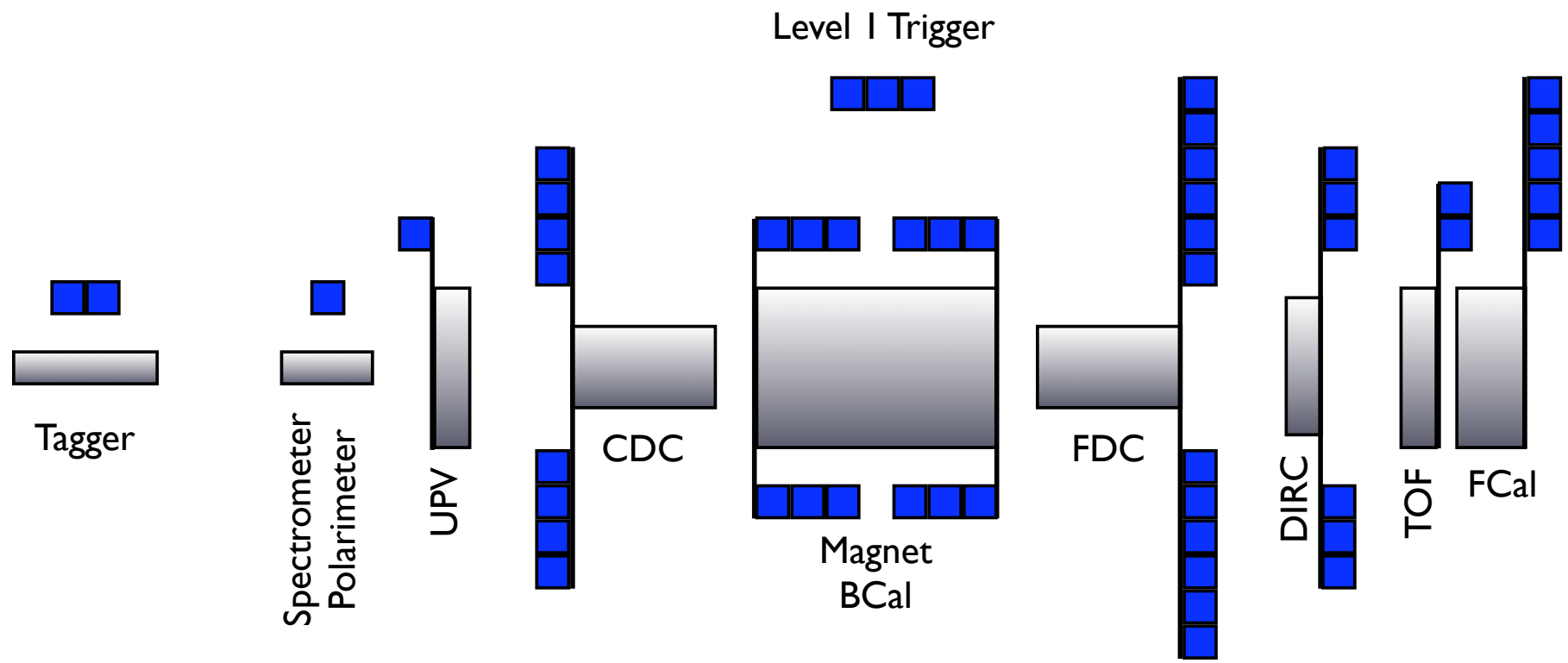
“Civil”

(Slide from December 2003):

# Integration







GlueX “exploded” with racks